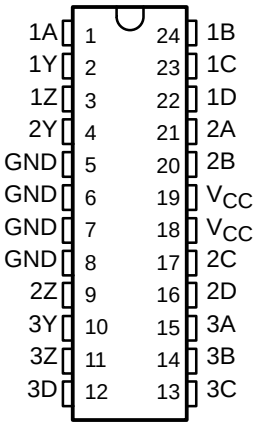
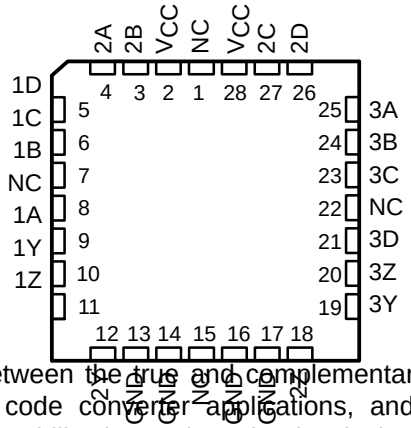
- **Less than 0.5-ns Skew Between True and Complementary Outputs**
- **High Capacitive-Drive Capability**
- **Curent Sink/Source Capability Up to 48 mA**
- **Approximately 35% Improvement in AC Performance over Schottky TTL**
- **Suitable for Use in Applications Such as: Differential Line Drivers, Complementary Input Circuit for Decoders and Code Converters, Symmetrical Complementary Clock Generators**
- **New Flow-Through Architecture to Optimize PCB Layout**
- **Center-Pin V_{CC} and GND Configurations to Minimize High-Speed Switching Noise**
- **EPIC™ (Enhanced-Performance Implanted CMOS) 1-μm Process**
- **500-mA Typical Latch-Up Immunity at 125°C**
- **Package Options Include “Small Outline” Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs**
- **Dependable Texas Instruments Quality and Reliability**

l1802 . . . JT PACKAGE
l1802 . . . DW OR NT PACKAGE

(T0P VIEW)



11802 . . . FK PACKAGE
VIEW)



description

The 54AC11802 is especially suitable for symmetrical complementary clock-generator applications due to the delay time in either function (OR/NOR) being typically 4 ns with less than 0.5 ns skew between the true and complementary outputs. Elimination of decode spikes in symmetrical decoder and code converter applications, and the high capacitive-drive capability coupled with high current-sinking capability (48 mA), make the device useful for applications such as a decoder or differential line driver.

The 54AC11802 is characterized for operation over the full military temperature range of −55°C to 125°C. The 74AC11802 is characterized for operation from −40°C to 85°C.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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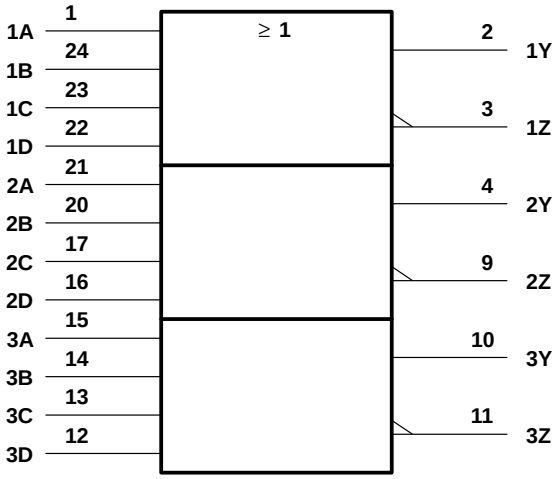
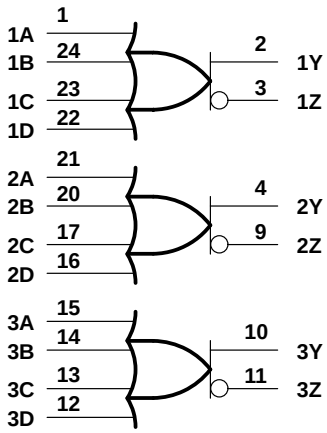
FUNCTION TABLE

INPUTS				OUTPUTS	
A	B	C	D	Z	Y
H	X	X	X	H	L
X	H	X	X	H	L
X	X	H	X	H	L
X	X	X	H	H	L
L	L	L	L	L	H

logic symbol†



logic diagram



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for DW, JT, and NT packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} . . . . . −0.5 V to 7 V
Input voltage range, V_I (see Note 1) . . . . . −0.5 V to V_{CC} + 0.5 V
Output voltage range, V_O (see Note 1) . . . . . −0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} (V_I < 0 or V_I > V_{CC}) . . . . . ±20 mA
Output clamp current, I_{OK} (V_O < 0 or V_O > V_{CC}) . . . . . ±50 mA
Continuous output current, I_O (V_O = 0 to V_{CC}) . . . . . ±50 mA
Continuous current through V_{CC} or GND pins . . . . . ±150 mA
Storage temperature range . . . . . −65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp current ratings are observed.

recommended operating conditions

			54AC11802			74AC11802			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage (see note 2)		3	5	5.5	3	5	5.5	V
V_{IH}	High-level input voltage	V_{CC} = 3 V	2.1			2.1			V
		V_{CC} = 4.5 V	3.15			3.15			
		V_{CC} = 5.5 V	3.85			3.85			
V_{IL}	Low-level input voltage	V_{CC} = 3 V			0.9			0.9	V
		V_{CC} = 4.5 V			1.35			1.35	
		V_{CC} = 5.5 V			1.65			1.65	
V_I	Input voltage		0		V_{CC}	0		V_{CC}	V
V_O	Output voltage		0		V_{CC}	0		V_{CC}	V
I_{OH}	High-level output current	V_{CC} = 3 V			−4			−4	mA
		V_{CC} = 4.5 V			−24			−24	
		V_{CC} = 5.5 V			−24			−24	
I_{OL}	Low-level output current	V_{CC} = 3 V			12			12	mA
		V_{CC} = 4.5 V			24			24	
		V_{CC} = 5.5 V			24			24	
$\Delta t/\Delta v$	Input transition rise or fall rate		0		10			10	ns/V
T_A	Operating free-air temperature		−55		125	−40		85	°C

NOTE 2: All V_{CC} and GND pins must be connected to the proper voltage supply

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	T_A = 25°C			54AC11802		74AC11802		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	I_{OH} = –50 µA	3 V	2.9			2.9		2.9		V
		4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
	I_{OH} = –4 µA	3 V	2.58			2.4		2.48		
	I_{OH} = –24 mA	4.5 V	3.94			3.7		3.8		
		5.5 V	4.94			4.7		4.8		
	I_{OH} = –50 mA†	5.5 V				3.85				
	I_{OH} = –75 mA†	5.5 V						3.85		
V_{OL}	I_{OL} = 50 µA	3 V			0.1		0.1		0.1	V
		4.5 V			0.1		0.1		0.1	
		5.5 V			0.1		0.1		0.1	
	I_{OL} = 12 mA	3 V			0.36		0.5		0.44	
	I_{OL} = 24 mA	4.5 V			0.36		0.5		0.44	
		5.5 V			0.36		0.5		0.44	
	I_{OL} = 50 mA†	5.5 V					1.65			
	I_{OL} = 75 mA†	5.5 V							1.65	
I_I	V_I = V_{CC} or GND	5.5 V			±0.1		±1		±1	µA
I_{CC}	V_I = V_{CC} or GND, I_O = 0	5.5 V			4		80		40	µA
C_i	V_I = V_{CC} or GND	5 V		4						pF

† Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V, (unless otherwise noted), (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T_A = 25°C		T_A = MIN to MAX‡				UNIT
			'AC11802		54AC11802		74AC11802		
			MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A, B, C, or D	Y							ns
t_{PHL}									
t_{PLH}	A, B, C, or D	Y							ns
t_{PHL}									

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V, (unless otherwise noted), (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T_A = 25°C		T_A = MIN to MAX‡				UNIT
			'AC11802		54AC11802		74AC11802		
			MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A, B, C, or D	Y							ns
t_{PHL}									
t_{PLH}	A, B, C, or D	Y							ns
t_{PHL}									

‡ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS		TYP	UNIT
C_{pd}	Power dissipation capacitance per gate	C_L = 50 pF,	f = 1 MHz		pF

PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_L includes probe and jig capacitance.
B. Input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r = 3 ns, t_f = 3 ns.
C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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